TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (L^2 - π -MOSV)

2SJ401

DC-DC Converter, Relay Drive and Motor Drive Applications

• 4 V gate drive

• Low drain–source ON resistance : $RDS(ON) = 33 \text{ m}\Omega \text{ (typ.)}$

• High forward transfer admittance $: |Y_{fs}| = 20 \text{ S (typ.)}$ • Low leakage current $: I_{DSS} = -100 \,\mu\text{A (max) (V}_{DS} = -60 \,\text{V)}$

• Enhancement-mode : $V_{th} = -0.8 \sim -2.0 \text{ V (V}_{DS} = -10 \text{ V, I}_{D} = -1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-60	V	
Drain-gate voltage (Ro	_{SS} = 20 kΩ)	V_{DGR}	-60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	-20	Α	
	Pulse(Note 1)	I_{DP}	-80	Α	
Drain power dissipation	n (Tc = 25°C)	P_{D}	100	W	
Single pulse avalanche	e energy (Note 2)	E _{AS}	800	mJ	
Avalanche current		I _{AR}	-20	Α	
Repetitive avalenche e	nergy (Note 3)	E _{AR}	10	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature ra	ange	T _{stg}	-55~150	°C	

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	83.3	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

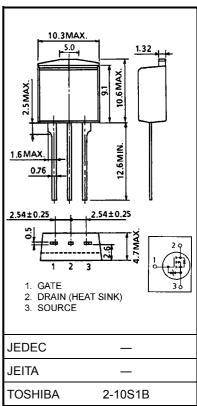
Note 2: V_{DD} = -50 V, T_{ch} = 25°C (initial), L = 1.44 mH, R_G = 25 Ω , I_{AR} = -20 A

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

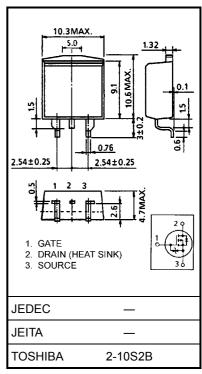
This transistor is an electrostatic sensitive device.

Please handle with caution.

Unit: mm



Weight: 1.5 g (typ.)



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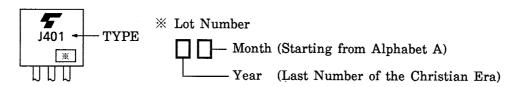
Electrical Characteristics (Ta = 25°C)

Charac	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ	
Drain cut-off cur	rent	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	_	_	-100	μΑ	
Drain-source br	eakdown voltage	V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-60	_	_	V	
Gate threshold v	oltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.8	_	-2.0	V	
Duein accurace ON resistants		R _{DS (ON)}	V _{GS} = -4 V, I _D = -10 A	_	50	90	mΩ	
Drain-source ON resistance	V _{GS} = -10 V, I _D = -10 A		_	33	45			
Forward transfer	admittance	Y _{fs}	V _{DS} = -10 V, I _D = -10 A	10	20	_	S	
Input capacitanc	е	C _{iss}		_	2800	_		
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		450	_	pF	
Output capacitance		Coss		_	1300	_		
Switching time	Rise time	t _r	$V_{GS} = \begin{array}{c} 0V \\ -10V \end{array}$ $V_{GS} = \begin{array}{c} 1D = -10A \\ V_{OUT} \\ R_{L} = \\ 3\Omega \end{array}$	_	15	_	- ns	
	Turn-on time	t _{on}		_	35	_		
	Fall time	t _f		_	25	_		
	Turn-off time	t _{off}	$V_{DD} = -30V$ $Duty \le 1\%, \ t_{W} = 10 \mu s$	_	120	_		
Total gate charg plus gate-drain)		Qg			90	_		
Gate-source charge		Q_{gs}	$V_{DD} \approx -48 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -20 \text{ A}$		65	_	nC -	
Gate-drain ("miller") charge		Q _{gd}			25	_		

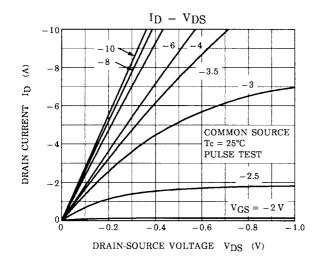
Source-Drain Ratings and Characteristics (Ta = 25°C)

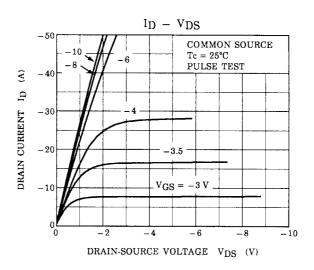
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_		_	-20	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_			-80	Α
Forward voltage (diode)	V_{DSF}	$I_{DR} = -20 \text{ A}, V_{GS} = 0 \text{ V}$		_	1.7	V
Reverse recovery time	t _{rr}	I _{DR} = -20 A, V _{GS} = 0 V	_	75	_	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 50 A / μs	_	83	_	nC

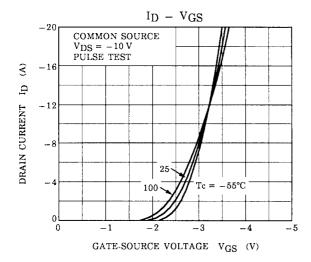
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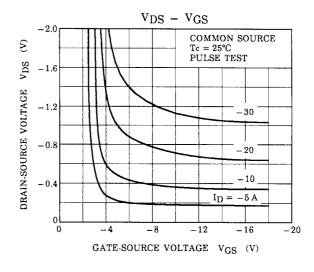


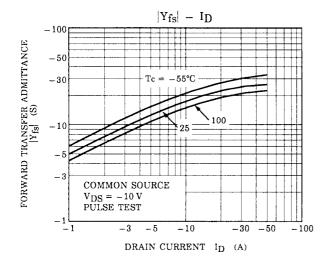
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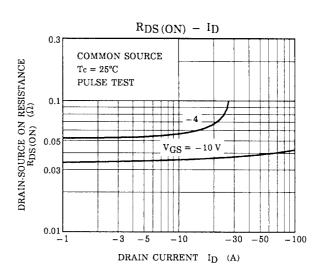




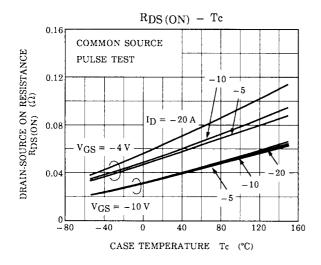


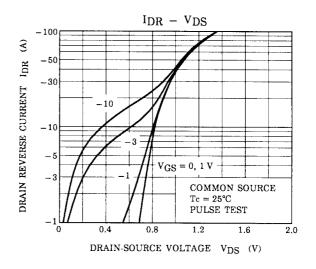


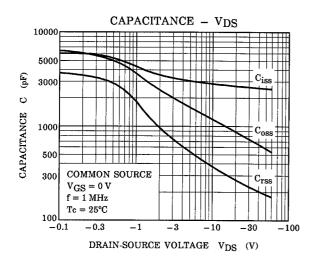


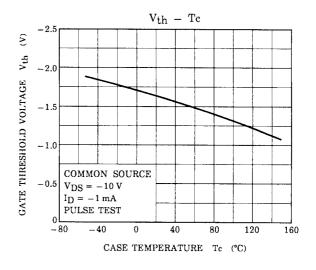


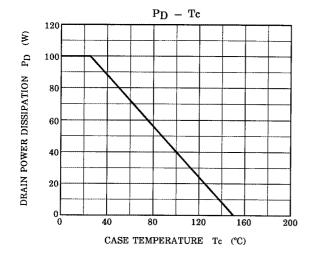
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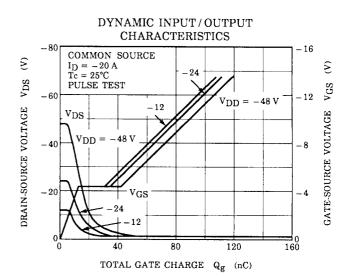




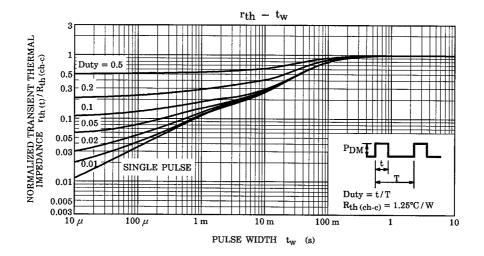


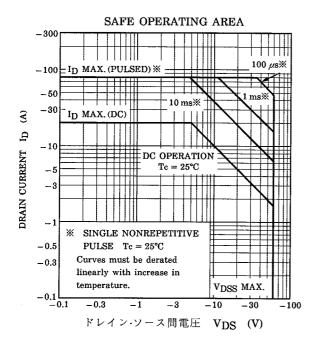


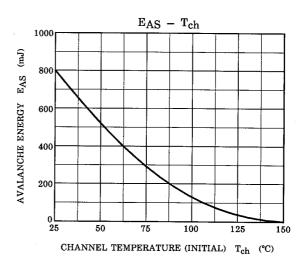


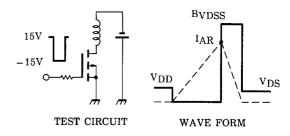


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 $R_G = 25\Omega$ $V_{DD} = -50V$, L = 1.44mH

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 $E_{AS} \!=\! \frac{1}{2} \cdot L \cdot I^2 \cdot (\frac{B_{VDSS}}{B_{VDSS} \!-\! V_{DD}})$

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